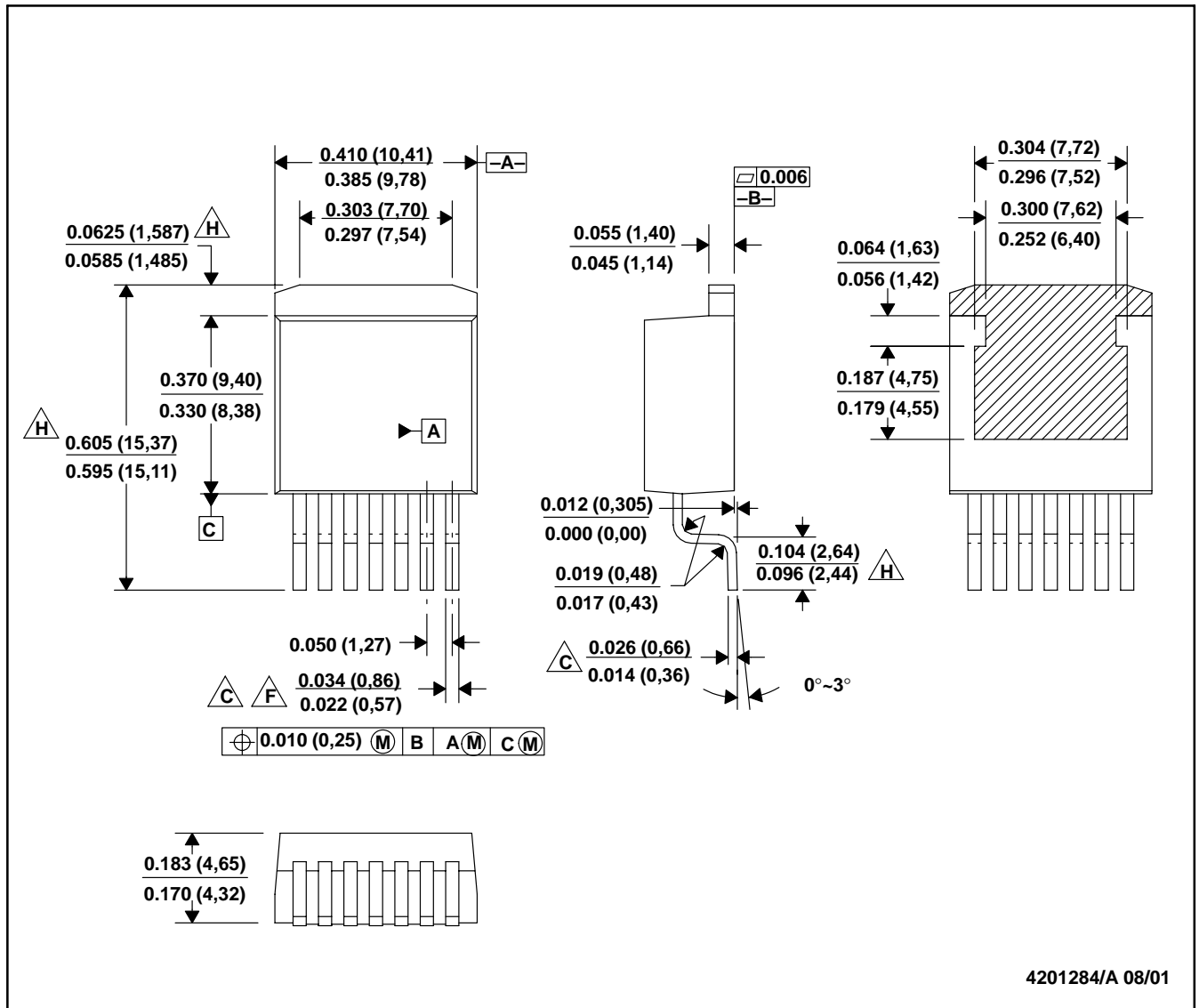


KTW (R-PSFM-G7)

PLASTIC FLANGE-MOUNT



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - $\triangle C$ . Lead width and height dimensions apply to the plated lead.
  - D. Leads are not allowed above the Datum B.
  - E. Stand-off height is measured from lead tip with reference to Datum B.
  - $\triangle F$ . Lead width dimension does not include dambar protrusion. Allowable dambar protrusion shall not cause the lead width to exceed the maximum dimension by more than 0.003".
  - G. Cross-hatch indicates exposed metal surface.
  - $\triangle H$ . Falls within JEDEC MO-169 with the exception of the dimensions indicated.

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